



RECOMMENDED PCB LAYOUT

- Note:
- Material:
 - Housing: High temperature thermoplastic with g.f, UL94V-0
 - Contact: copper alloy, t=0.15mm
 - Shell: copper alloy, t=0.25mm
 - Specification:
 - Current rating: 1 A Max.
 - Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - Contact resistance: 50 mW Max.
 - Insulation resistance: 100 MW Min.
 - Total mating force: 3.57 Kgf Max.
 - Total unmating force: 1.0 Kgf Min. 0.81~2.05 Kgf Min.
 - Temperature range: -30°C~80°C

1	2	3	4	5	6	7	8
REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE			

PART NO	MATERIAL:	深圳市迈瑞康电子有限公司					
MODEL NO: XX	FINSH:						
UNIT: MM	SIZE: A4						
TOLERANCE UNSPECIFIED	DR:	Micro usb 5s B Type Smt贴片式无导位无接地片					
.x 0.25	CHK:	DWG NO: MRK-MU09-085-0013					
.xx 0.20	APP:	SCALE: 5:1					
.xxx 0.15		DATE: 2012.06.18					
Ang. 2°		REV: A					

